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Washington,	D.C. 20231	First Named Inventor		~	Stephen G. Kelly, et al.				
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ndividual Name	Michael A. Sileo, Jr.						GY CE	27	ָ ֖֖֡֝
Address	Microsemi Corporation								
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NOTE: Signatures of all the inventors or assigness of record of the entire interest or their representative(s) are required. Submit multiple forms if more than one signature is required, see below.

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•	Applicant/	Patent Owner: Microsemi Corpora	EMENT UNDER 37 CFR 3	1,73(b)	
	Application	No./Patent No.: 10/085,164	Filed/jegue Date:	Enhance on cone	
	Entitled: E	ncapsulated Die Package with Imp	Proved Paresitio and Thornat De-	reorusty 26, 2002	
	Microsemi			romance	
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TI	he undersign	ned (whose title is supplied below)	is empowered to sign this watern	uppl on behalf of the assigned	_
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To the Ass't Commissioner for Patents. Please record the attached original documents or copy thereof. 1. Name of conveying party(ies): Stephen G. Kelly Kenneth R. Philpot Henricus Berrnadus Antonius Giesen William E. Doherty, Jr. City:	FORM PTO-1595 Docket Number: A539WTN	RECORDATION FO	RM COVER SHEET	U.S. Depar	rtment of Commercial Trademark Office
1. Name of conveying party(es): Stephen G. Kelly Kenneth R. Philpot Henricus Bermadus Antonius Giesen William E. Doherty, Jr. 3. Nature of Conveyance: X. Assignment Security Agreement Change of Name Other Security Agreement Change of Name Other Execution Date: March 28, 2002, April 2, 2002, April 8, 2002, and April 9, 2002 4. Application number(s) or patent number(s). This document is being filed together with a new application. Execution date of the application: February 26, 2002 Title: ENCAPSULATED DIE PACKAGE WITH IMPROVED PARASITIC AND THERMA PERFORMANCE A. Patent Application No.(s) S.N 10085,164 Filed: February 26, 2002 Additional number attached? Yes X. No Additional number attached? Yes X. No Some and address of party (so whom correspondence concerning document is being filed together with a new application. Execution date of the application: February 26, 2002 Additional number attached? Yes X. No Additional number attached? Yes X. No Some and address of party to whom correspondence concerning document should be mailed: Michael A. Silco, Jr. Microsemi Corporation Michael A. Silco, Jr. Microse			•	7	- Trademark Offic
Execution date of the application: February 26, 2002 Title: ENCAPSULATED DIE PACKAGE WITH IMPROVED PARASITIC AND THERMA PERFORMANCE A. Patent Application No.(s) S.N 10/085,164 Filed: February 26, 2002 Additional number attached?YesXNo	 Name of conveying party(ies): Stephen G. Kelly Kenneth R. Philpot Henricus Berrnadus Antonius Gie 		2. Name and Address of Name: Micro Address: 2381 City: Irvine Country: USA	receiving party(ies): osemi Corporation Morse Avenue c, CA 92614 lress(es) attached?	
Execution date of the application: February 26, 2002 Title: ENCAPSULATED DIE PACKAGE WITH IMPROVED PARASITIC AND THERMA PERFORMANCE A. Patent Application No.(s) S.N 10085,164 Filed: February 26, 2002 Additional number attached?YesXNo	3. Nature of Conveyance:				<u> </u>
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8131 LBJ Freeway, Suite 800 Dallas, TX 75251-1333 7. Amount of fee enclosed: \$40. 8. Deposit Account No: 50-1752 DO NOT USE THIS SPACE 7. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.	Execution date of the application: Februar Title: ENCAPSULATED DIE PERFORMANCE A. Patent Application No.(s) S.N 10/085,164 Filed: February 26, 200 Additional number attached? Yes 5. Name and address of party to whom correspond document should be mailed: Michael A. Sileo, Jr.	ry 26, 2002 PACKAGE WIT	B. Patent No.(s) Additional numbers atta	ached?YesX	No
Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.	8131 LBJ Freeway, Suite 800 Dallas, TX 75251-1333	j			
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.	DO NOT USE THIS SPACE				
1	Statement and signature.				
Date Michael G. Cameron, Reg. No. 50,298	4-18-02	regoing information is true	me k		f the original

ATTORNEY'S DOCKET NO.
A539WTN

ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as hered, having invented certain new and useful improvements as below entitled, for which application for United States Letters Person is made, the said application having been accounted on the date and forth below; and

WHEREAS, MICROSTEMI CORPORATION, a companion organized and existing under the laws of the Stem of California, with its principal office at 2381 Morse Avenue, Irvine, California 92614 may insie thereon;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and saviga to the said MCCROSEMI CORPORATION, its successors and savigas, my customing it, title and interest in and to the said invention and in so the said application and all patents which may be granted therefore, and all divisions, retisates, authetications, continuations, and extensions therefore and interest the Commissions of Patents and Trademarks to issue all patents for said invention, or patent resulting therefore, insofar as my interest is concentred, to the said MCCROSEMI CORPORATION, as assigned of my customing, title and interest.

I also bereby sell and sarign to Microsemi Corronation, its movement and sarigns, my fixeign rights to the invention disclosed to said application, in all countries of the world, including the right to file applications and obtain paints under the terms of the International Convention for the Properties of Industrial Property, and of the European Paints Convention, and further agree to excess my sed all patent applications, assignments, affidavits, and my other papers in connection firstwell accessary to perfect such parent rights.

I hereby further surce that I will communicate to said MICROSEMI CORPORATION, or to its accompon, sariges, and legal representatives, any facts known to re-respecting said invention, and at the expense of said sarignes company, sartiy in any legal proceedings, sign all levelid papers, execute all divisional, condutation, reissue and substitute applications, under all levelid caths, and generally do everything possible to aid said MECROSEMI CORPORATION, its successors, easigns and nominees to obtain and enforce proper patent protection for said invention in all comparies.

IN WITNESS WHERBOF, I bereinto set hand and seal this day and your,

TITLE OF INVENTION	ENCAPSULATED PARASITIC AND	DIE PACKAGE WITH THERMAL PERFORM	IMPROVED ANCE
SIGNATURE OF INVENTOR AND NAME	(1)Stephen G. Kolly	(2)Kenneth R. Philpot	(3) Henricus Bernacius Antonius Glesen
DATE	Men & root	28 mm2 02	APRIL 9,2002
RESIDENCE (City, County, State)	Molrose, Middlesex, Massachusetts	Nashua, Hillsborough, New Hampshire	Didam, The Netherlands

After recording return Assignment to:

Michael A. Sileo, Jr. Microsemi Corporation 8131 LBJ Freeway, Suite 800 Dallas, TX 75251-1333 ATTORNEY'S DOCKET NO.
A539WTN

ASSIGNMENT

WHERRAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made, the said application having been executed on the date set forth below; and

WHEREAS, MICROSEMI CORPORATION, a corporation organized and existing under the laws of the State of California, with its principal office at 2381 Morse Avenue, Irvine, California 92614 may issue thereon;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby soll and assign to the said MICROSEMI CORPORATION, its successors and assigns, my entire right, title and interest in and to the said invention and in to the said application and all patents which may be granted therefore, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner of Patents and Trademarks to issue all patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to the said MICROSEMI CORPORATION, as assignee of my entire right, title and interest.

I also hereby sell and assign to MICROSEMI CORPORATION, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further agree that I will communicate to said MICROSEMI CORPORATION, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful caths, and generally do everything possible to aid said MICROSEMI CORPORATION, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

IN WITNESS WHEREOF, I hereunto set hand and seal this day and year;

TITLE OF INVENTION	ENCAPSULATED PARASITIC AND		E WITH IMPROVED ERFORMANCE
SIGNATURE OF INVENTOR AND NAME	(4)William E. Doherty, Jr.	(5)	(6)
DATE	2April 102		
RESIDENCE (City, County, State)	Bedford, Middlesex, Massachusetts		

After recording return Assignment to:

Michael A. Sileo, Jr. \
Microsemi Corporation
8131 LBJ Freeway, Suite 800
Dallas, TX 75251-1333